## TOSHIBA

TOSHIBA Photocoupler Photo Relay

# TLP227G, TLP227G-2

Cordless Telephone PBX Modem

The TOSHIBA TLP227G series consist of a gallium arsenide infrared emitting diode optically coupled to a photo–MOS FET in a plastic DIP package.

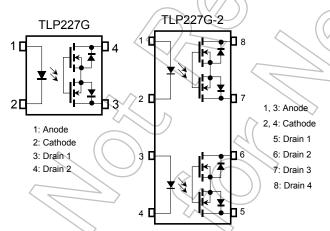
The TLP227G series are a bi-directional switch which can replace mechanical relays in many applications.

- TLP227G: 4 pin DIP(DIP4), 1 channel type(1 form A)
- TLP227G-2: 8 pin DIP(DIP8), 2 channel type(2 form A)
- Peak off-state voltage: 350 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 120 mA (max)
- On-state resistance:  $35 \Omega$  (max)
- Isolation voltage: 2500 Vrms (min)
- Isolation thickness: 0.4mm(min)
- UL approved: UL1577, File No.E67349 Under application
- cUL approved CSA Component Acceptance Service No. 5A, File No.E67349

Option (V4) VDE approved : DIN EN60747-5-5 (Note 1)

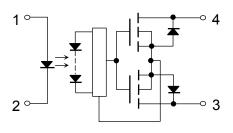
(Note 1) : When a EN60747-5-5 approved type is needed, please designate "Option(V4)"

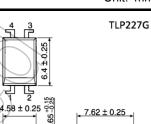
#### Pin Configuration (top view)

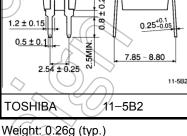


#### **Internal Circuit**



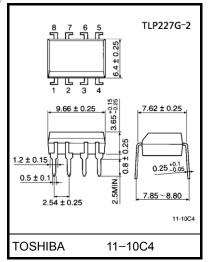




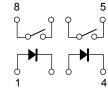


1 Form A





Weight: 0.54g (typ.) 2 Form A 8



Start of commercial production 1995-11

Unit: mm

#### Absolute Maximum Ratings (Ta = 25°C)

		Characteristic			Symbol	Rating	Unit
	Forward current				١ <sub>F</sub>	50	mA
LED	Forward current derating (Ta ≥ 25°C)				ΔI <sub>F</sub> / °C	-0.5	mA / °C
	Peak forward current (100µs pulse, 100pps)				I <sub>FP</sub>	<u> </u>	А
	Reverse voltage				VR	5	V
	Diode power dissipation				PD	50	mW
	Diode power dissipation	derating (Ta ≥ 25	°C)		∆P <sub>D</sub> /°C	-0.5	mW/°C
	Junction temperature				Ţj	125	°C
	Off-state output terminal voltage				VOFF	350	V
	On-state current	TLP227G			6	120	
		TLP227G-2	One channel		ION	) 120	mA
		TLF227G-2	Both channel	(Note 1)		100	
		TLP227G	LP227G			-1.2	
ctor	On-state current derating(Ta ≥ 25°C)	TLP227G-2	One channel	6	∆lon/°C	-1.2	mA / °C
Detector			Both channel	(Note 1)			$\sim$
	Output power dissipation	TLP227G			432	$\mathcal{O}_{mW}$	
		TLP227G-2	20	Po	600		
	Output power dissipation	TLP227G	$\langle \rangle$	ΔP <sub>O</sub> /°C	-4.32		
	(Ta ≥ 25°C)		TLP227G-2	TLP227G-2		-6.0	mW / °C
	Junction temperature	20	$\searrow$	тј (🗸	125	°C	
Sto	Storage temperature range				T <sub>stg</sub>	-55 to 125	°C
Оре	Operating temperature range					-40 to 85	°C
Lea	d soldering temperature (	10 s)	T <sub>opr</sub> T <sub>sol</sub>	260	°C		
Isol	ation voltage (AC, 1 minu	te, R.H. ≤ 60%)	BVS	2500	V <sub>rms</sub>		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1): Two channels operating simultaneously.

(Note 2): Device considered a two-terminal device: LED side pins shorted together, and detector side pins shorted together.



#### **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	V <sub>DD</sub>	—	_	280	V
Forward current	١ <sub>F</sub>	5	7.5	25	mA
On-state current	I <sub>ON</sub>	—	_	100	mA
Operating temperature	T <sub>opr</sub>	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

#### Individual Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	-	_	10	μA
	Capacitance	CT	VF = 0 V, f = 1 MHz	X	30		pF
tor	Off-state current	IOFF	V <sub>OFF</sub> = 350 V		12	1	μA
Detector	Capacitance	C <sub>OFF</sub>	V = 0 V, f = 1 MHz	25	40	_	pF

#### Coupled Electrical Characteristics (Ta = 25°C)

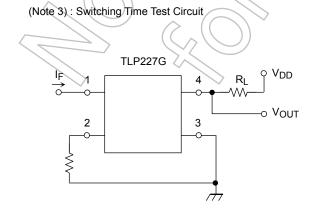
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I <sub>FT</sub>	I <sub>ON</sub> = 120 mA		2	3	mA
On-state resistance	Pou	I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA	-(C	22	35	Ω
	R <sub>ON</sub>	I <sub>ON</sub> = 20 to 120 mA, I <sub>F</sub> = 5 mA	Ś	26	40	52
Return LED current	I <sub>FC</sub>	l <sub>OFF</sub> = 100 μA	70.1	$\rightarrow$	—	mA

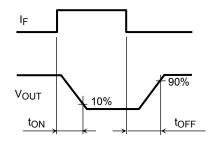
### Isolation Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V <sub>S</sub> = 0 V, f = 1MHz	_	0.8	_	pF
Isolation resistance	Rs	V <sub>S</sub> = 500V, R.H. ≤ 60%	5×10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
	$\mathcal{C}$	AC, 1 minute	2500	_	_	V
Isolation voltage	BVS	AC, 1 second (in oil)	_	5000	_	V <sub>rms</sub>
(C		DC, 1 minute (in oil)	—	5000	_	V <sub>dc</sub>

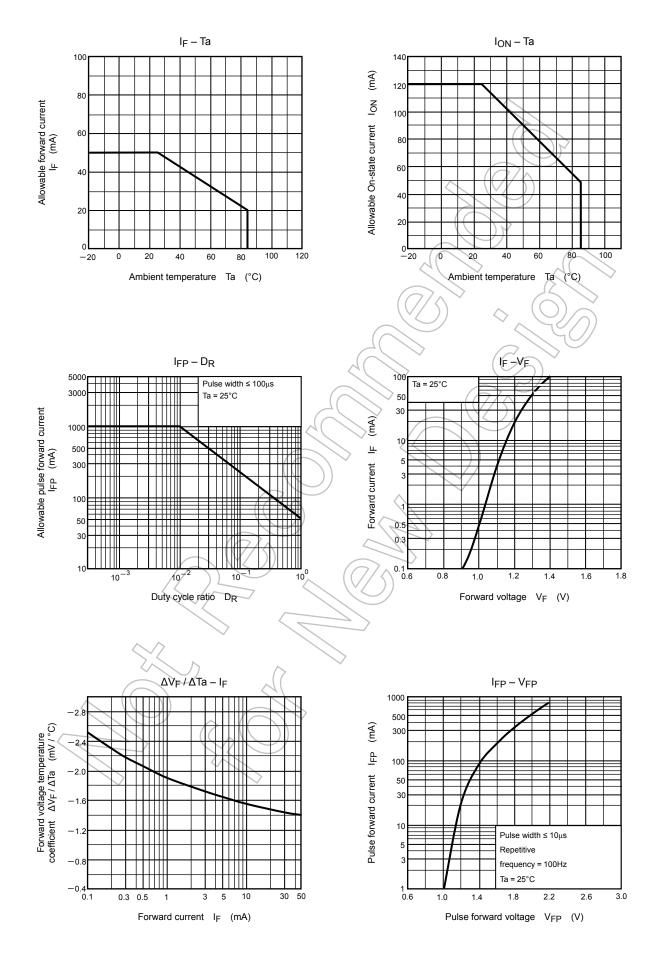
#### Switching Characteristics (Ta = 25°C)

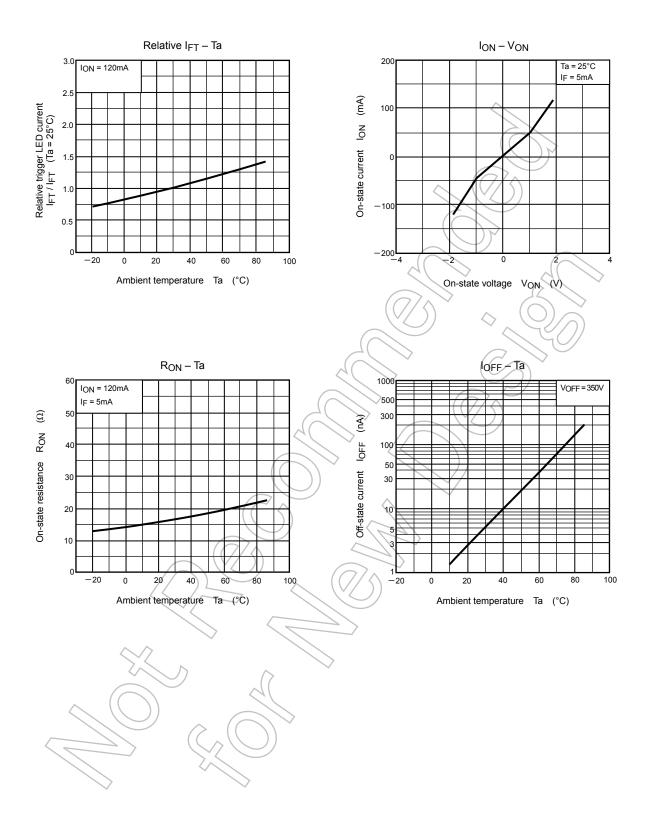
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton	R <sub>L</sub> = 200 Ω	—	0.3	1	<b>m</b> 0
Turn-off time	tOFF	V <sub>DD</sub> = 20 V, I <sub>F</sub> = 5 mA (Note 3)	_	0.1	1	ms





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